TOSHIBA WWW.

Surface Mount LED

TLRE1005B

Features

3.2 (L) x 2.4 (W) x 2.4 (H) mm
2 mm lens top type
InGaAIP LED
Reflow soldering is possible
Standard embossed taping 4 mm pitch : T03 (1000 pcs/reel)

Applications

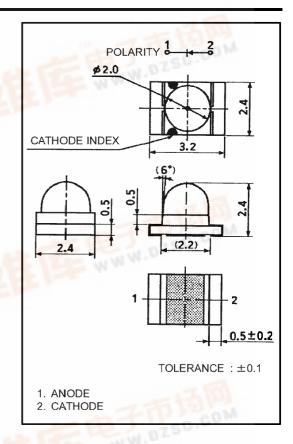
High-output backlighting source Battery-powered equipment Message boards Portable devices Computer peripherals

Maximum Ratings (Ta=25°C)

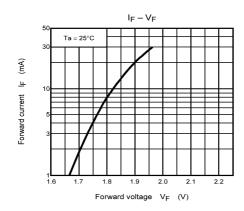
Characteristic	Symbol	Max.	Unit	
Forward Current	lF	25	mA	
Reverse Voltage	VR	4.00	V	
Power Dissipation	Po	60.00	mW	
Operating Temperature	Topr	-40 ~ 85	°C	
Storage Temperature	Tstg	-40 ~ 100	°C	
Soldering Temperature	Tsol	260	°C	
Soldering Time		for 3 sec. max	- F G	

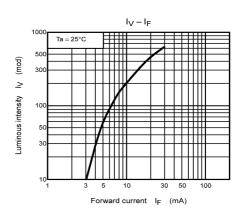
Onto-Electrical Characteristics (Ta-25°C)

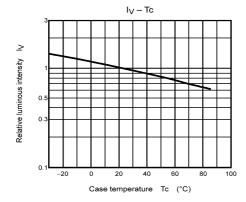
Characteristic	Symbol	Test Condition	Min	Тур	Max	Unit
Forward Voltage	VF	I=20mA	-	1.90	2.40	٧
Reverse Current	lr	V _R =4V	-	_	50	μΑ
Luminous Intensity	lv	I=20mA	153.00	450.00	-	mcd
Viewing Angle	2θ ^{1/2}	-	_	45°	-	deg.
Peak Wavelength	λр	I=20mA	_	644	-	nm
Dominant Wavelength	λd	I=20mA	- F	630	-	nm
Spectral Line Half Width	Δλ	I _F =20mA	1/2	18		nm

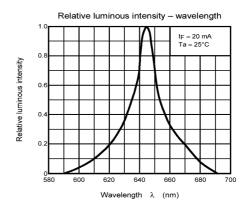


TLRE1005B Graphs

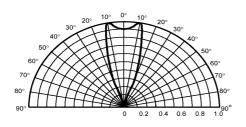


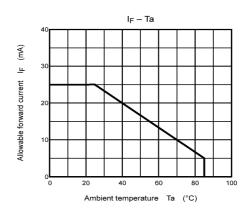












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Surface Mount LED

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